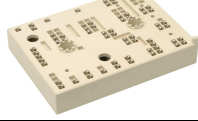
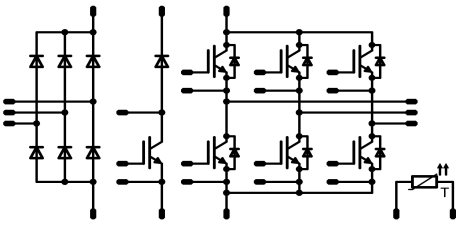




| MiniSKiiP® 3 PIM | 1200 V / 75 A |
|---|--|
| <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Features</p> <ul style="list-style-type: none"> Solderless interconnection Mitsubishi Generation 6.1 technology </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Target Applications</p> <ul style="list-style-type: none"> Industrial Motor Drives </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Types</p> <ul style="list-style-type: none"> V23990-K429-A60-PM </div> | <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">MiniSKiiP® 3 housing</p>  </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Schematic</p>  </div> |

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|--|----------------------|--|-----------|--------------------|
| Rectifier Diode | | | | |
| Repetitive peak reverse voltage | V_{RRM} | | 1600 | V |
| DC forward current | I_{FAV} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 71 | A |
| Surge (non-repetitive) forward current | I_{FSM} | $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$ | 490 | A |
| I2t-value | I^2t | | 1200 | A ² s |
| Power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 77 | W |
| Maximum Junction Temperature | T_{jmax} | | 150 | °C |
| Inverter Switch / Brake Switch | | | | |
| Collector-emitter breakdown voltage | V_{CE} | | 1200 | V |
| DC collector current | I_C | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 69 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 150 | A |
| Turn off safe operating area | | $V_{CE} \leq 1200V, T_j \leq T_{op\ max}$ | 150 | A |
| Power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 151 | W |
| Gate-emitter peak voltage | V_{GE} | | 20 | V |
| Short circuit ratings | t_{SC} V_{CC} | $T_j \leq 150\text{ °C}$ $V_{GE} = 15\text{ V}$ | 10 850 | μs V |
| Maximum Junction Temperature | T_{jmax} | | 175 | °C |

**Maximum Ratings** $T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|-----------|--------|-----------|-------|------|
|-----------|--------|-----------|-------|------|

Inverter Diode / Brake Diode

| | | | | |
|---------------------------------|------------|---------------------------------------|------|----|
| Peak Repetitive Reverse Voltage | V_{RRM} | | 1200 | V |
| DC forward current | I_F | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 63 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 150 | A |
| Power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 127 | W |
| Maximum Junction Temperature | T_{jmax} | | 175 | °C |

Thermal Properties

| | | | | |
|---|-----------|--|----------------------------|----|
| Storage temperature | T_{sig} | | -40...+125 | °C |
| Operation temperature under switching condition | T_{op} | | -40...+($T_{jmax} - 25$) | °C |

Isolation Properties

| | | | | |
|----------------------------|----------|----------------------------------|----------|----|
| Isolation voltage | V_{is} | $t = 2\text{ s}$ DC Test Voltage | 4000 | V |
| Creepage distance | | | min 12,7 | mm |
| Clearance | | | min 12,7 | mm |
| Comparative tracking index | CTI | | >200 | |



Characteristic Values

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|--------------|-----------|-----------|------------|-----|-------|-----|--|------|
| | | V_{GE} [V] | V_r [V] | I_C [A] | T_j [°C] | Min | Typ | Max | | |

Rectifier Diode

| | | | | | | | | | | |
|---|---------------|---|--|--|------|-----------|---|--------------|-----|-----|
| Forward voltage | V_F | | | | 50 | 25 125 | 1 | 1,09 1,02 | 1,8 | V |
| Threshold voltage (for power loss calc. only) | V_{th} | | | | 50 | 25 125 | | 0,88 0,74 | | V |
| Slope resistance (for power loss calc. only) | r_t | | | | 50 | 25 125 | | 4,0 6,0 | | mΩ |
| Reverse current | I_r | | | | 1600 | 25 145 | | | 1,1 | mA |
| Thermal resistance junction to sink | $R_{th(j-s)}$ | Thermal grease thickness ≤ 50um λ = 1 W/mK | | | | | | 0,90 | | K/W |

Inverter Switch / Brake Switch

| | | | | | | | | | | | |
|---|---------------|--|-----|------|----|--------|-----------|------|--------------|-----|-----|
| Gate emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | | 0,0075 | 25 | 5,4 | 6 | 6,6 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | | 75 | 25 150 | 1 | 1,82 2,18 | 2,4 | V |
| Collector-emitter cut-off current incl. Diode | I_{CES} | | 0 | 1200 | | | 25 | | | 0,3 | mA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | | 25 | | | 500 | nA |
| Integrated Gate resistor | R_{gint} | | | | | | | none | | | Ω |
| Turn-on delay time | $t_{d(on)}$ | $R_{goff} = 8 \Omega$ $R_{gonn} = 8 \Omega$ | ±15 | 600 | 75 | | 25 | | 83 | ns | |
| Rise time | t_r | | | | | | 150 | | 82 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | | 25 | | 15 | | |
| Fall time | t_f | | | | | | 150 | | 18 | | |
| Turn-on energy loss | E_{on} | | | | | | 25 | | 157 | | |
| Turn-off energy loss | E_{off} | | | | | | 150 | | 204 | | |
| Input capacitance | C_{ies} | | | | | | | 7500 | | pF | |
| Output capacitance | C_{oss} | $f = 1 \text{ MHz}$ | 0 | 10 | | 25 | | 1500 | | | |
| Reverse transfer capacitance | C_{rss} | | | | | | | 130 | | | |
| Gate charge | Q_G | | ±15 | 600 | 75 | 25 | | | 175 | nC | |
| Thermal resistance junction to sink | $R_{th(j-s)}$ | Thermal grease thickness ≤ 50um λ = 1 W/mK | | | | | | | 0,63 | | K/W |

Inverter Diode / Brake Diode

| | | | | | | | | | | | |
|---------------------------------------|----------------------|---|-----|-----|----|----|-----------|---|--------------|-----|-----|
| Diode forward voltage | V_F | | | | | 75 | 25 150 | 1 | 2,67 2,18 | 3,4 | V |
| Peak reverse recovery current | I_{RRM} | $R_{goff} = 8 \Omega$ | ±15 | 600 | 75 | | 25 | | 54 | ns | |
| Reverse recovery time | t_{rr} | | | | | | 150 | | 73 | | |
| Reverse recovered charge | Q_{rr} | | | | | | 25 | | 276 | | |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | | | | | | 150 | | 602 | | |
| Reverse recovered energy | E_{rec} | | | | | | 25 | | 5,46 | | |
| | | | | | | | 150 | | 15,61 | | |
| Thermal resistance junction to sink | $R_{th(j-s)}$ | Thermal grease thickness ≤ 50um λ = 1 W/mK | | | | | | | 0,75 | | K/W |

Thermistor

| | | | | | | | | | | | |
|----------------------------|----------------|-------------------------|--|--|--|-----|--|----|-----------------------|---|------------------|
| Rated resistance | R | | | | | 25 | | | 1000 | | Ω |
| Deviation of R_{100} | $\Delta_{R/R}$ | $R_{100} = 1670 \Omega$ | | | | 100 | | -3 | | 3 | % |
| Power dissipation | P | | | | | 100 | | | 1670,3 | | Ω |
| Power dissipation constant | | | | | | 25 | | | 0,76 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. % | | | | 25 | | | $7,635 \cdot 10^{-3}$ | | 1/K |
| B-value | $B_{(25/100)}$ | Tol. % | | | | 25 | | | $1,731 \cdot 10^{-5}$ | | 1/K ² |
| Vincotech NTC Reference | | | | | | 25 | | | | E | |

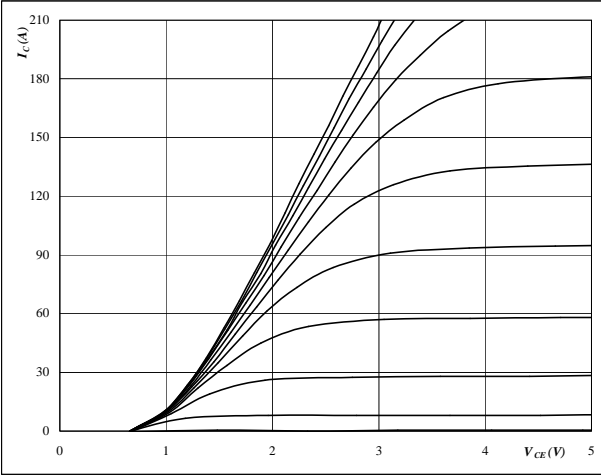


Inverter / Brake Characteristics

figure 1. IGBT

Typical output characteristics

$I_C = f(V_{CE})$



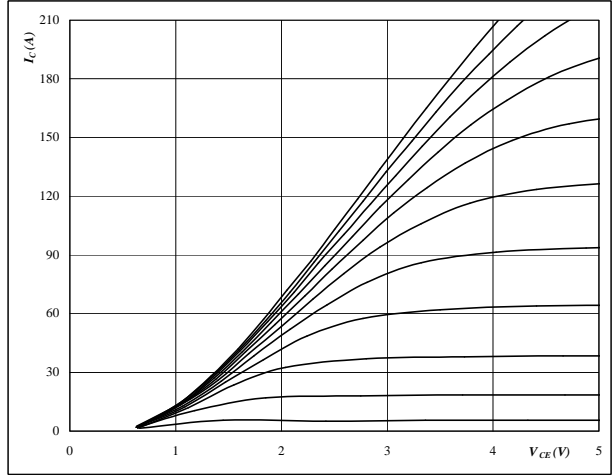
At

$t_p = 250 \mu s$
 $T_j = 25 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 2. IGBT

Typical output characteristics

$I_C = f(V_{CE})$



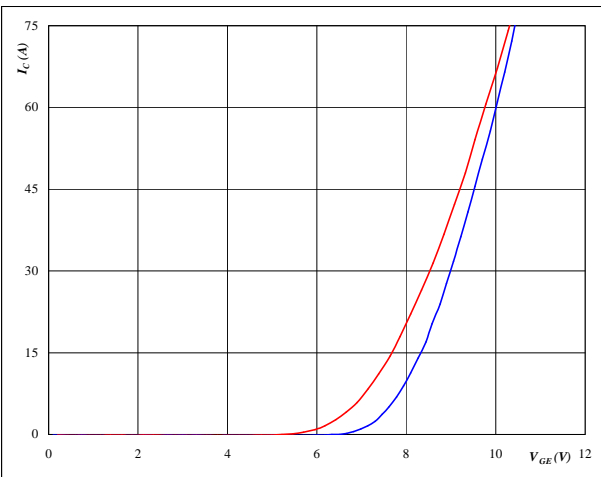
At

$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$



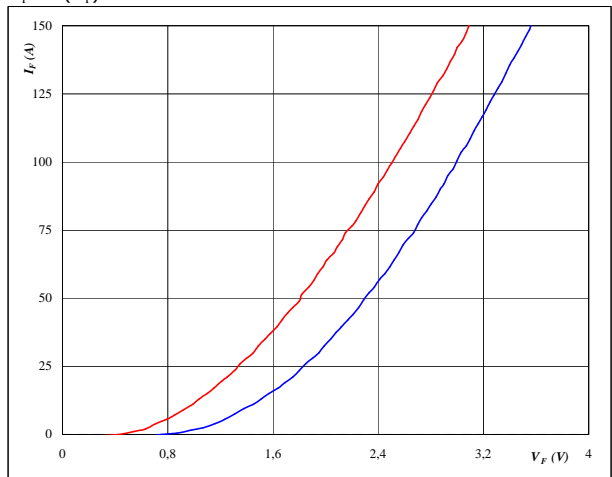
At

$T_j = 25/150 \text{ } ^\circ C$
 $t_p = 250 \mu s$
 $V_{CE} = 10 \text{ V}$

figure 4. FWD

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



At

$T_j = 25/150 \text{ } ^\circ C$
 $t_p = 250 \mu s$

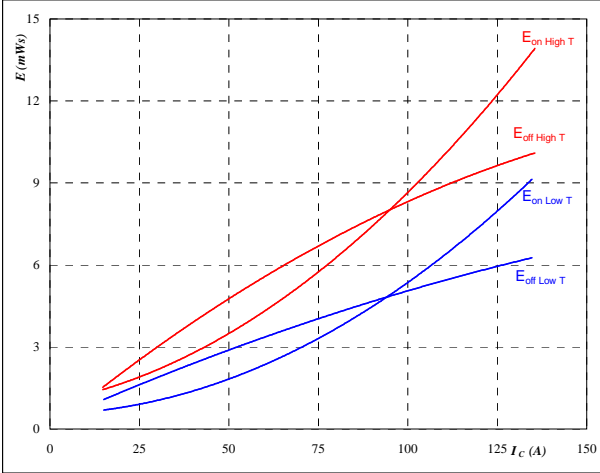


Inverter / Brake Characteristics

figure 5. IGBT

Typical switching energy losses as a function of collector current

$E = f(I_C)$



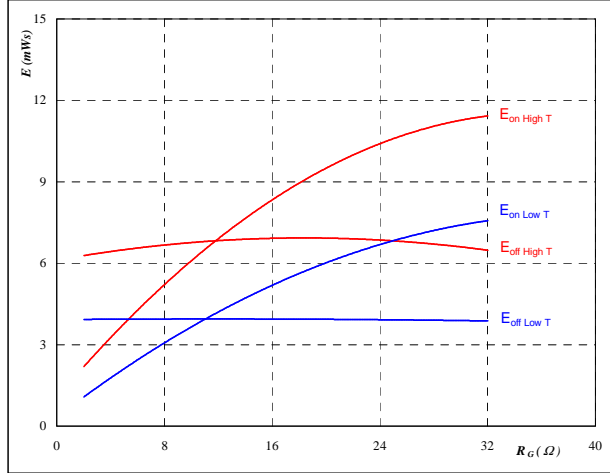
With an inductive load at

| | | |
|--------------|--------|----|
| $T_j =$ | 25/150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $R_{gon} =$ | 8 | Ω |
| $R_{goff} =$ | 8 | Ω |

figure 6. IGBT

Typical switching energy losses as a function of gate resistor

$E = f(R_G)$



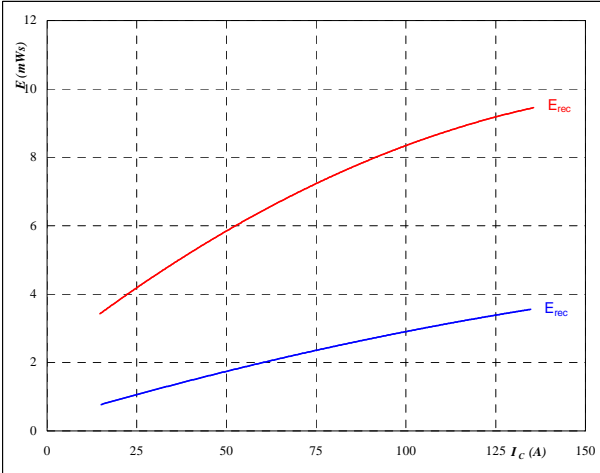
With an inductive load at

| | | |
|------------|--------|----|
| $T_j =$ | 25/150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $I_C =$ | 75 | A |

figure 7. FWD

Typical reverse recovery energy loss as a function of collector current

$E_{rec} = f(I_C)$



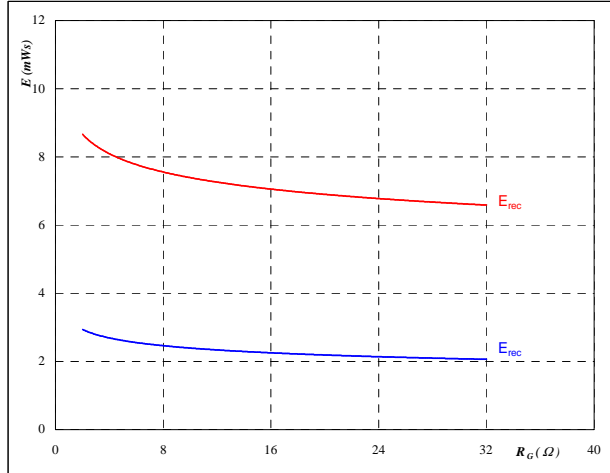
With an inductive load at

| | | |
|-------------|--------|----|
| $T_j =$ | 25/150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $R_{gon} =$ | 8 | Ω |

figure 8. FWD

Typical reverse recovery energy loss as a function of gate resistor

$E_{rec} = f(R_G)$



With an inductive load at

| | | |
|------------|--------|----|
| $T_j =$ | 25/150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $I_C =$ | 75 | A |

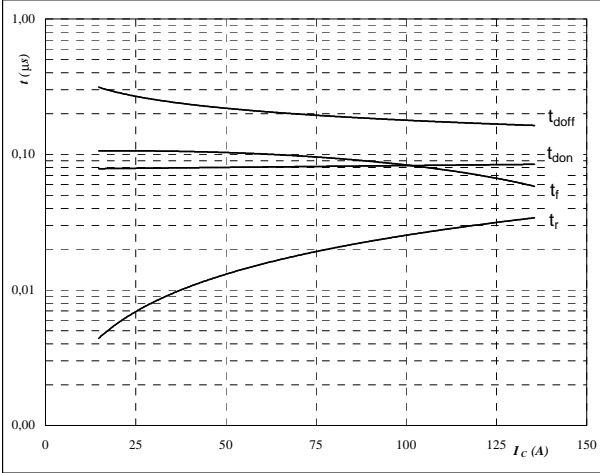


Inverter / Brake Characteristics

figure 9. IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



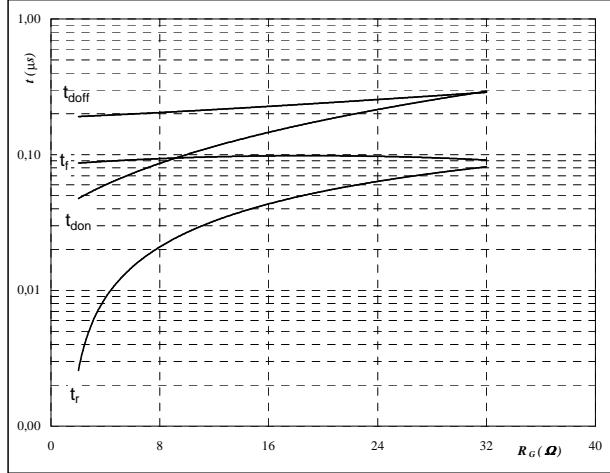
With an inductive load at

| | | |
|--------------|-----|----|
| $T_j =$ | 150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $R_{gon} =$ | 8 | Ω |
| $R_{goff} =$ | 8 | Ω |

figure 10. IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$



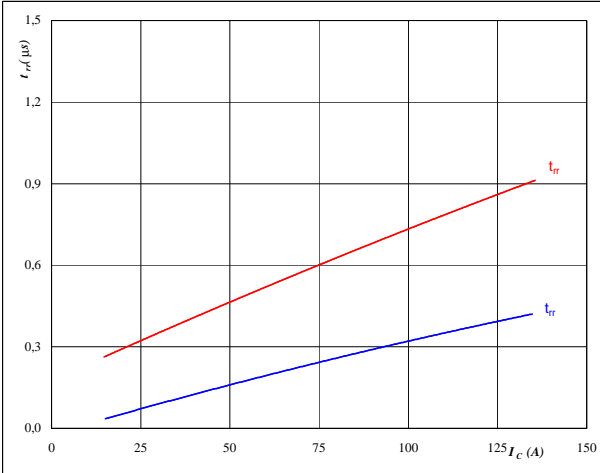
With an inductive load at

| | | |
|------------|-----|----|
| $T_j =$ | 150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $I_C =$ | 75 | A |

figure 11. FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



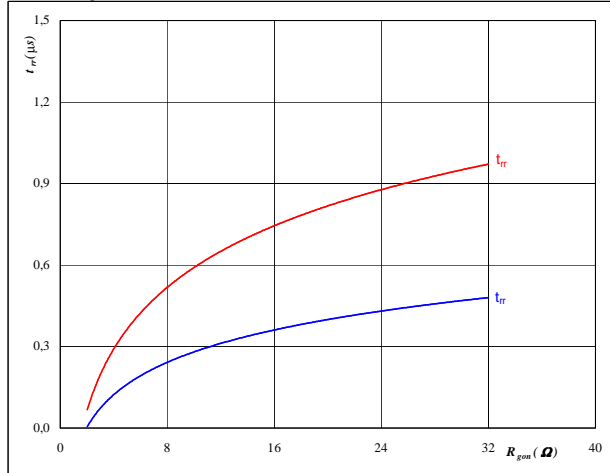
At

| | | |
|-------------|--------|----|
| $T_j =$ | 25/150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $R_{gon} =$ | 8 | Ω |

figure 12. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



At

| | | |
|------------|--------|----|
| $T_j =$ | 25/150 | °C |
| $V_R =$ | 600 | V |
| $I_F =$ | 75 | A |
| $V_{GE} =$ | ±15 | V |

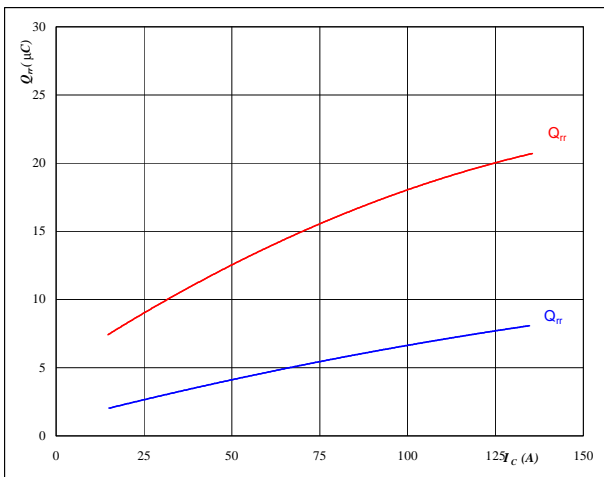


Inverter / Brake Characteristics

figure 13. FWD

Typical reverse recovery charge as a function of collector current

$Q_{rr} = f(I_C)$



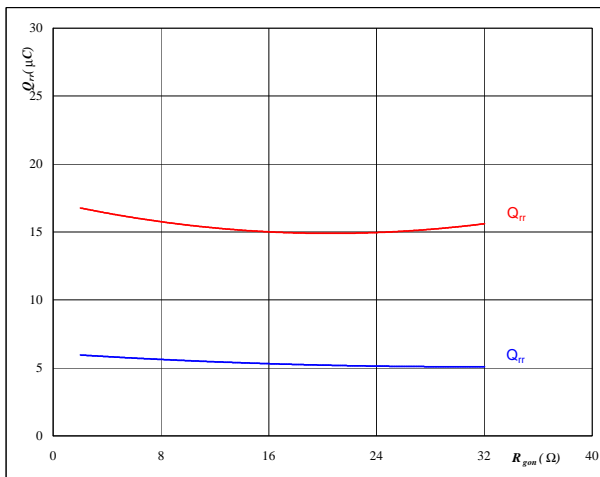
At

$T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

figure 14. FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$Q_{rr} = f(R_{gon})$



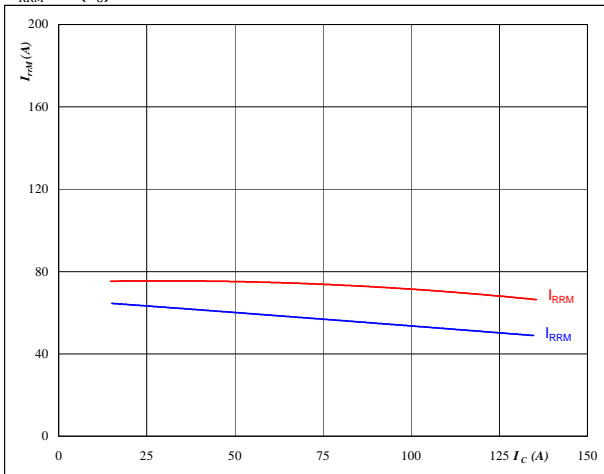
At

$T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

figure 15. FWD

Typical reverse recovery current as a function of collector current

$I_{RRM} = f(I_C)$



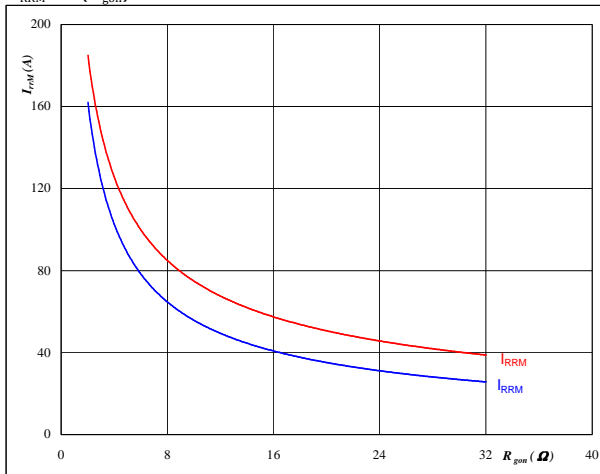
At

$T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

figure 16. FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$I_{RRM} = f(R_{gon})$



At

$T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

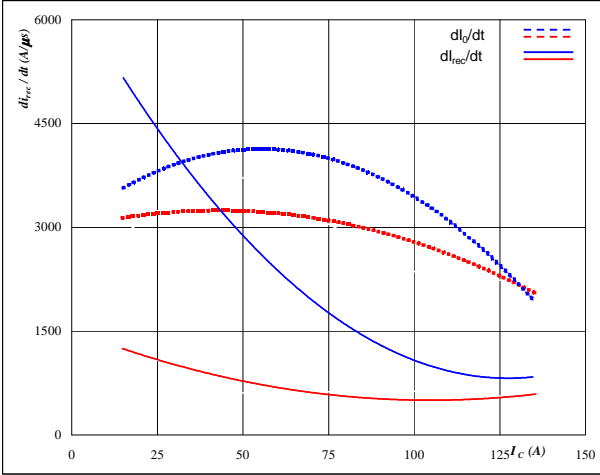


Inverter / Brake Characteristics

figure 17. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$dI_0/dt, dI_{rec}/dt = f(I_C)$$

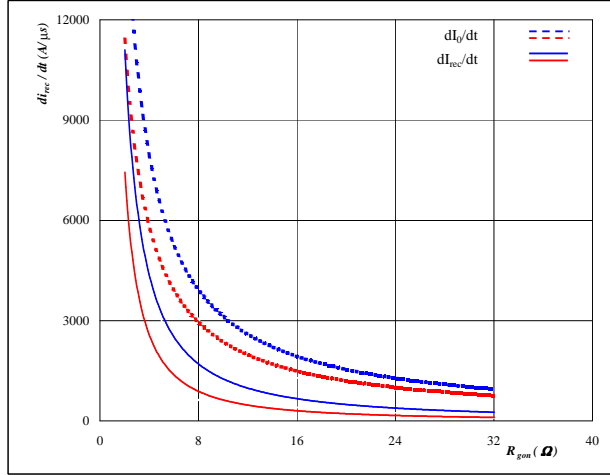


At
 $T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

figure 18. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

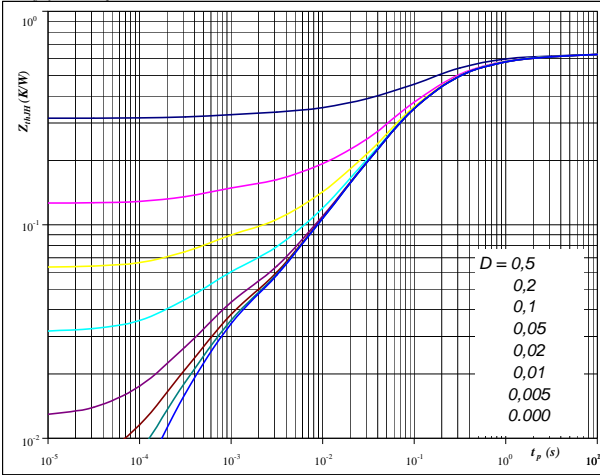


At
 $T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

figure 19. IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



At
 $D = t_p / T$
 $R_{th(j-s)} = 0,63$ K/W

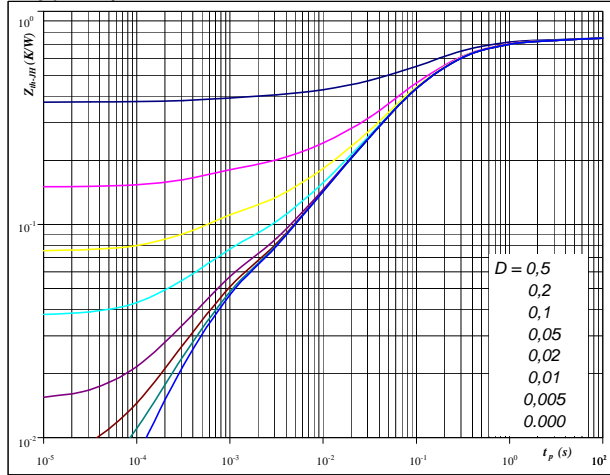
IGBT thermal model values

| R (K/W) | Tau (s) |
|----------|----------|
| 5,24E-02 | 2,97E+00 |
| 1,91E-01 | 3,64E-01 |
| 2,99E-01 | 7,94E-02 |
| 5,90E-02 | 9,84E-03 |
| 2,86E-02 | 5,22E-04 |

figure 20. FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



At
 $D = t_p / T$
 $R_{th(j-s)} = 0,75$ K/W

FWD thermal model values

| R (K/W) | Tau (s) |
|----------|----------|
| 5,75E-02 | 2,82E+00 |
| 2,67E-01 | 2,80E-01 |
| 3,09E-01 | 6,89E-02 |
| 7,65E-02 | 8,48E-03 |
| 3,88E-02 | 5,35E-04 |

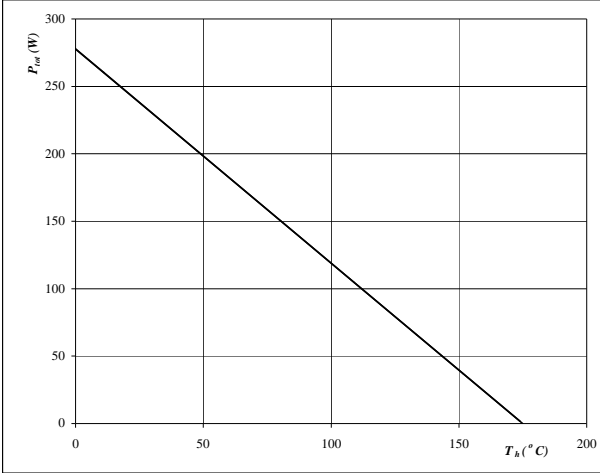


Inverter / Brake Characteristics

figure 21. IGBT

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_s)$

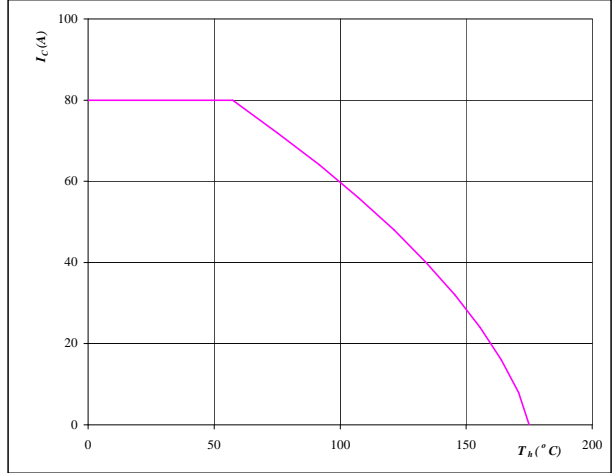


At
 $T_j = 175 \text{ °C}$

figure 22. IGBT

Collector current as a function of heatsink temperature

$I_C = f(T_s)$

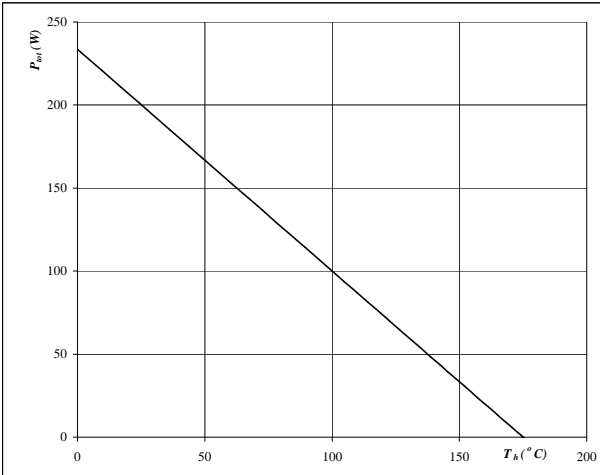


At
 $T_j = 175 \text{ °C}$
 $V_{GE} = 15 \text{ V}$

figure 23. FWD

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_s)$

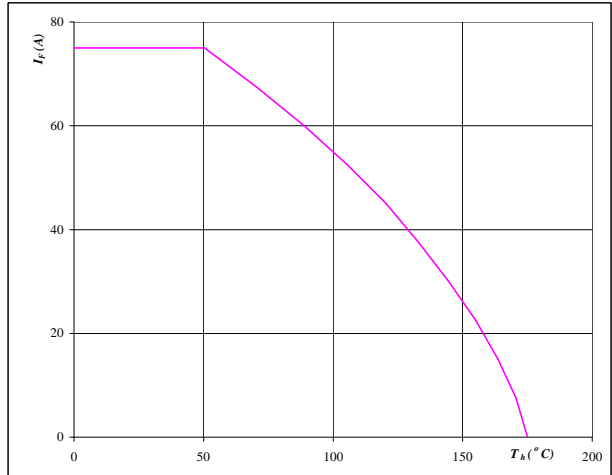


At
 $T_j = 175 \text{ °C}$

figure 24. FWD

Forward current as a function of heatsink temperature

$I_F = f(T_s)$



At
 $T_j = 175 \text{ °C}$

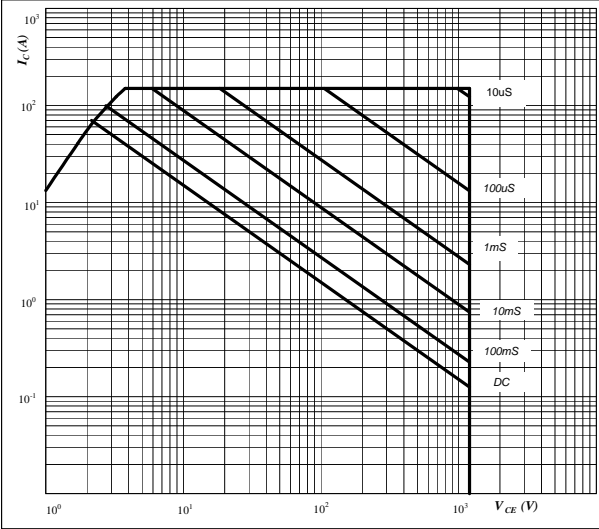


Inverter / Brake Characteristics

figure 25. IGBT

Safe operating area as a function of collector-emitter voltage

$$I_C = f(V_{CE})$$

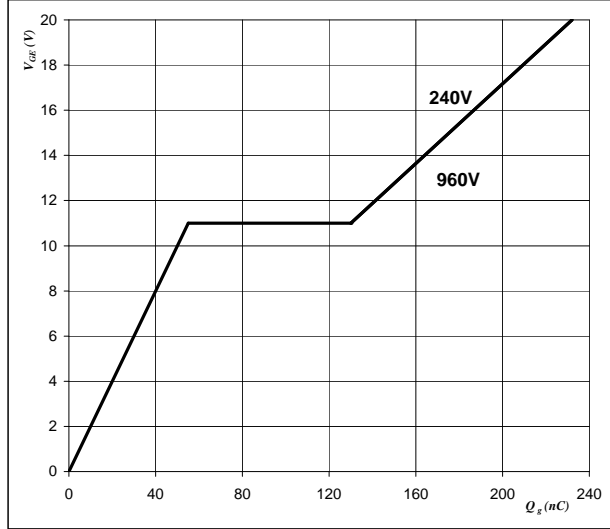


At
 $D =$ single pulse
 $T_s =$ 80 °C
 $V_{GE} =$ ±15 V
 $T_j =$ T_{jmax} °C

figure 26. IGBT

Gate voltage vs Gate charge

$$V_{GE} = f(Q_g)$$

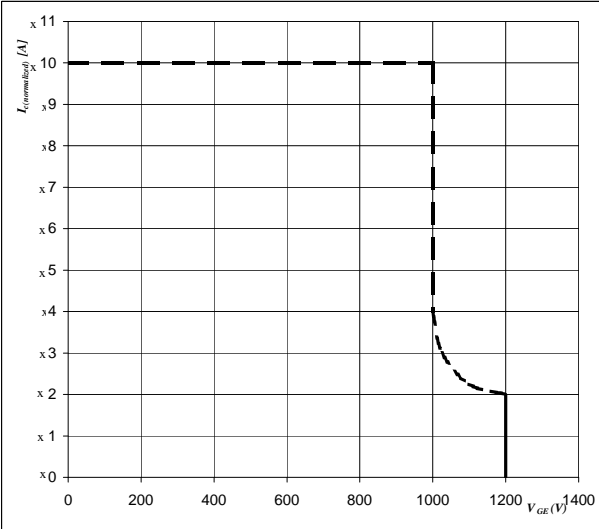


At
 $I_C =$ 75 A

figure 27. IGBT

Short circuit safe operating area (SCSOA)

$$I_C = f(V_{CE})$$

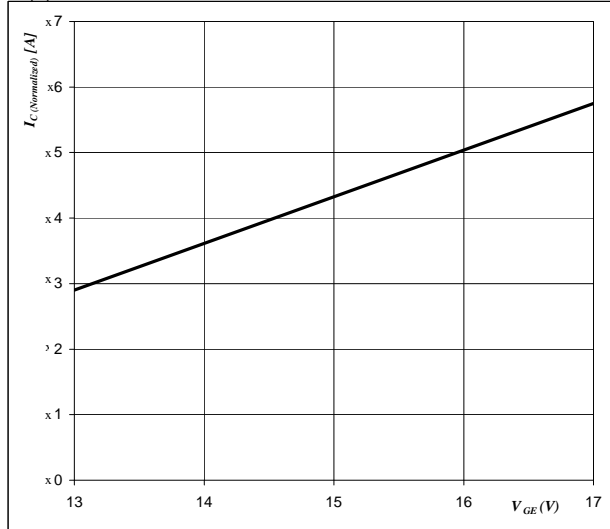


At
 $V_{CE} =$ 1200 V
 $T_j \leq$ 175 °C

figure 28. IGBT

Typical short circuit collector current as a function of gate-emitter voltage

$$I_{C(sc)} = f(V_{GE})$$

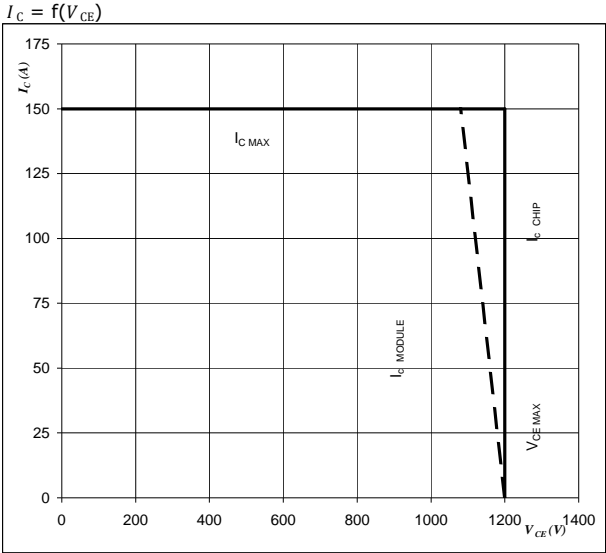


At
 $V_{CE} =$ 800 V
 $T_j =$ 150 °C



Inverter / Brake Characteristics

figure 28. IGBT Reverse bias safe operating area



At

$T_j = T_{jmax} - 25 \text{ } ^\circ\text{C}$

$U_{ccminus} = U_{ccplus}$

Switching mode : 3phase SPWM

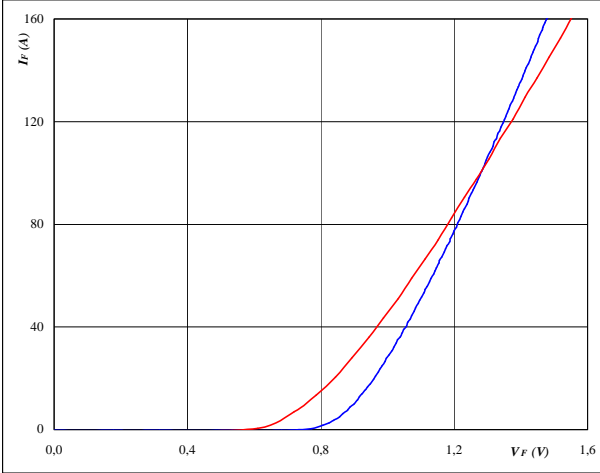


Rectifier Diode

figure 1. Rectifier Diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

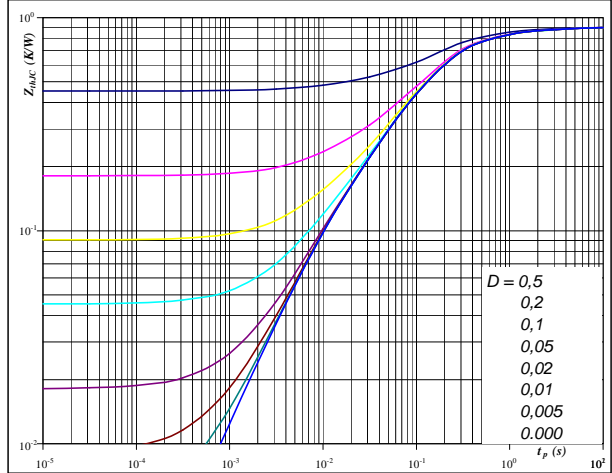


At
 $T_j = 25/125 \text{ } ^\circ\text{C}$
 $t_p = 250 \text{ } \mu\text{s}$

figure 2. Rectifier Diode

Diode transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$

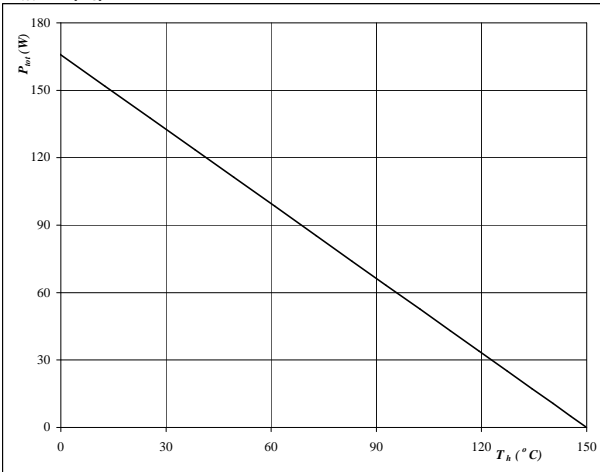


At
 $D = t_p / T$
 $R_{th(j-s)} = 0,90 \text{ K/W}$

figure 3. Rectifier Diode

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_s)$

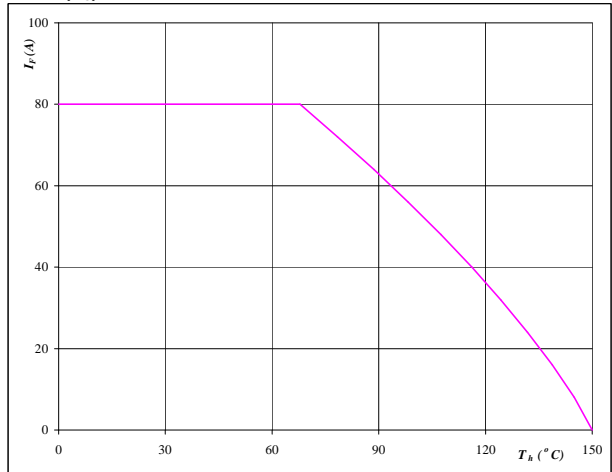


At
 $T_j = 150 \text{ } ^\circ\text{C}$

figure 4. Rectifier Diode

Forward current as a function of heatsink temperature

$I_F = f(T_s)$



At
 $T_j = 150 \text{ } ^\circ\text{C}$

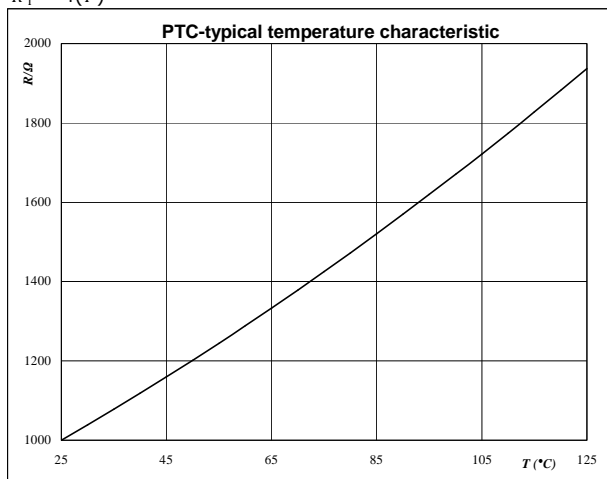


Thermistor

figure 1. Thermistor

**Typical PTC characteristic
as a function of temperature**

$$R_T = f(T)$$





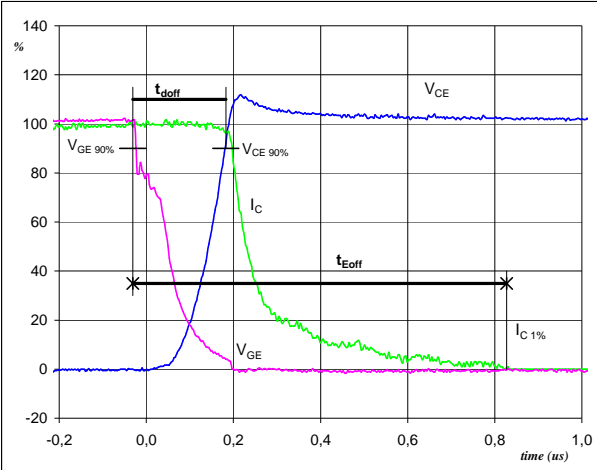
Switching Definitions Inverter

General conditions

| | | |
|------------|---|--------|
| T_j | = | 150 °C |
| R_{gon} | = | 8 Ω |
| R_{goff} | = | 8 Ω |

figure 1. IGBT

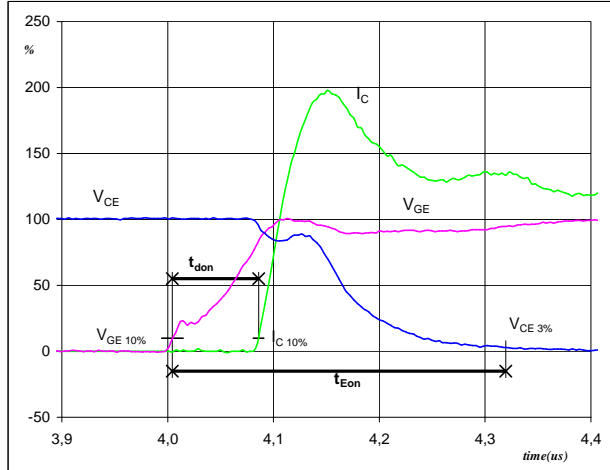
Turn-off Switching Waveforms & definition of t_{doff} t_{Eoff}
 (t_{Eoff} = integrating time for E_{off})



| | | |
|-------------------|------|----|
| V_{GE} (0%) = | -15 | V |
| V_{GE} (100%) = | 15 | V |
| V_C (100%) = | 600 | V |
| I_C (100%) = | 75 | A |
| t_{doff} = | 0,20 | μs |
| t_{Eoff} = | 0,86 | μs |

figure 2. IGBT

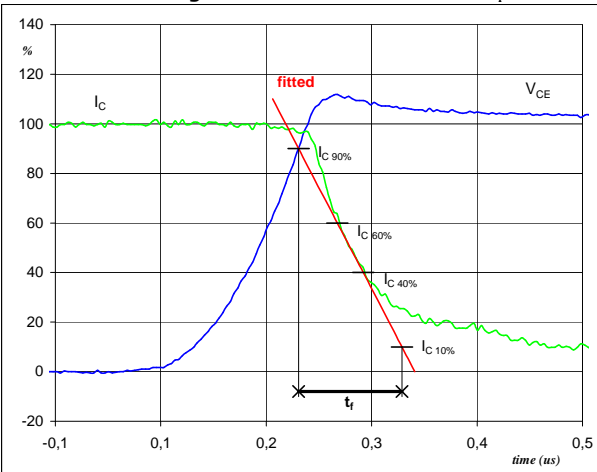
Turn-on Switching Waveforms & definition of t_{don} t_{Eon}
 (t_{Eon} = integrating time for E_{on})



| | | |
|-------------------|------|----|
| V_{GE} (0%) = | -15 | V |
| V_{GE} (100%) = | 15 | V |
| V_C (100%) = | 600 | V |
| I_C (100%) = | 75 | A |
| t_{don} = | 0,08 | μs |
| t_{Eon} = | 0,31 | μs |

figure 3. IGBT

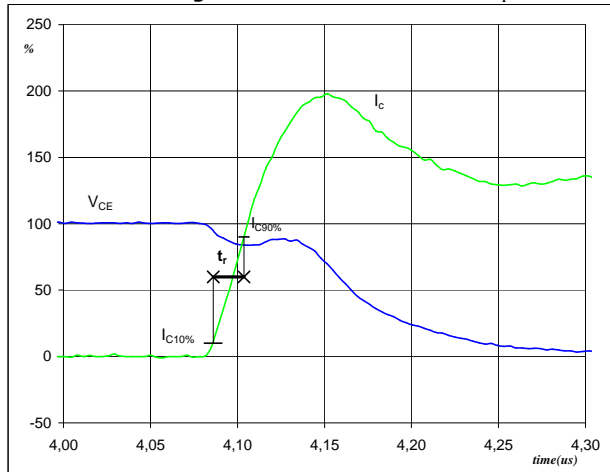
Turn-off Switching Waveforms & definition of t_f



| | | |
|----------------|------|----|
| V_C (100%) = | 600 | V |
| I_C (100%) = | 75 | A |
| t_f = | 0,10 | μs |

figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r

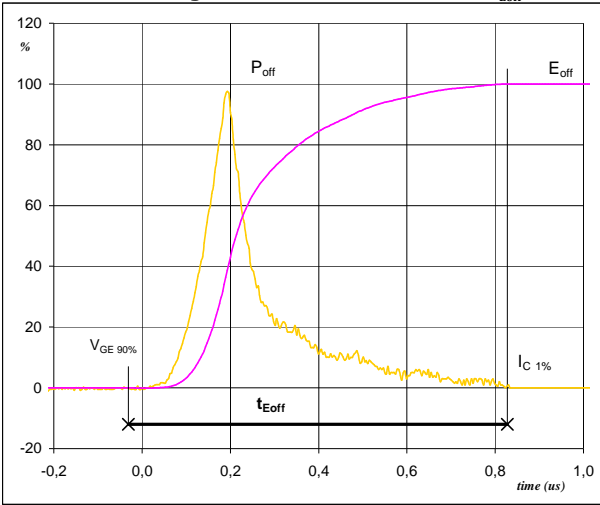


| | | |
|----------------|------|----|
| V_C (100%) = | 600 | V |
| I_C (100%) = | 75 | A |
| t_r = | 0,02 | μs |



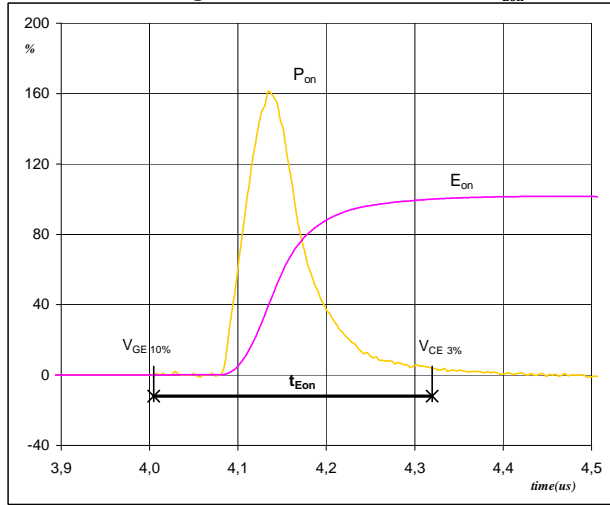
Switching Definitions Inverter

figure 5. IGBT
Turn-off Switching Waveforms & definition of t_{Eoff}



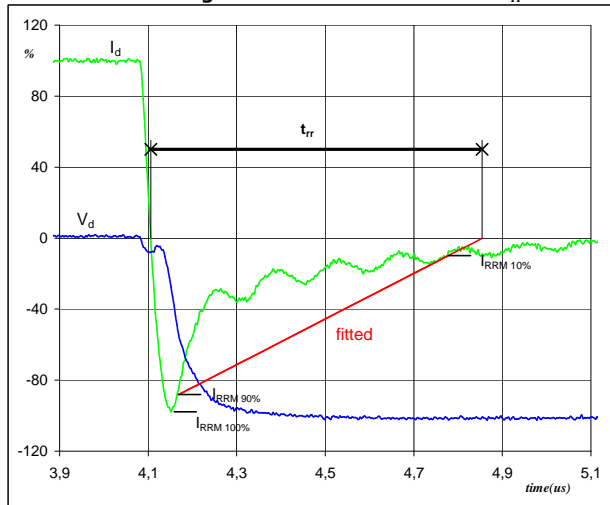
$P_{off} (100\%) = 44,94 \text{ kW}$
 $E_{off} (100\%) = 6,78 \text{ mJ}$
 $t_{Eoff} = 0,86 \text{ } \mu\text{s}$

figure 6. IGBT
Turn-on Switching Waveforms & definition of t_{Eon}



$P_{on} (100\%) = 44,94 \text{ kW}$
 $E_{on} (100\%) = 5,73 \text{ mJ}$
 $t_{Eon} = 0,31 \text{ } \mu\text{s}$

figure 8. FWD
Turn-off Switching Waveforms & definition of t_{rr}



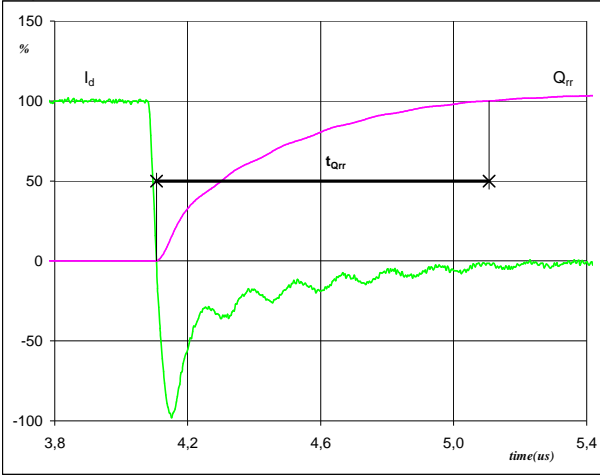
$V_d (100\%) = 600 \text{ V}$
 $I_d (100\%) = 75 \text{ A}$
 $I_{RRM} (100\%) = -73 \text{ A}$
 $t_{rr} = 0,60 \text{ } \mu\text{s}$



Switching Definitions Inverter

figure 9. FWD

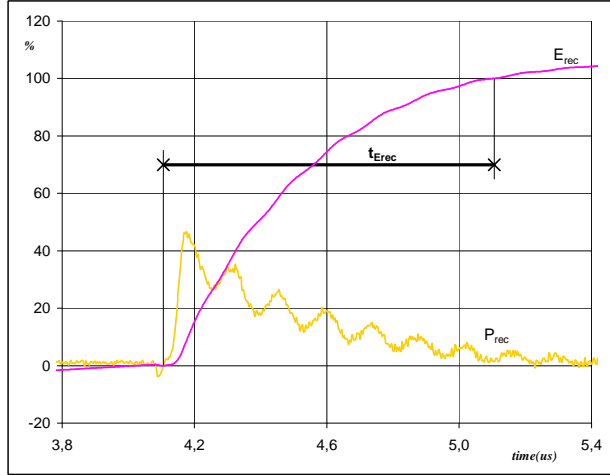
Turn-on Switching Waveforms & definition of t_{Qrr}
(t_{Qrr} = integrating time for Q_{rr})



| | | |
|-------------------|-------|---------------|
| I_d (100%) = | 75 | A |
| Q_{rr} (100%) = | 15,61 | μC |
| t_{Qrr} = | 1,00 | μs |

figure 10. FWD

Turn-on Switching Waveforms & definition of t_{Erec}
(t_{Erec} = integrating time for E_{rec})



| | | |
|--------------------|-------|---------------|
| P_{rec} (100%) = | 44,94 | kW |
| E_{rec} (100%) = | 7,29 | mJ |
| t_{Erec} = | 1,00 | μs |

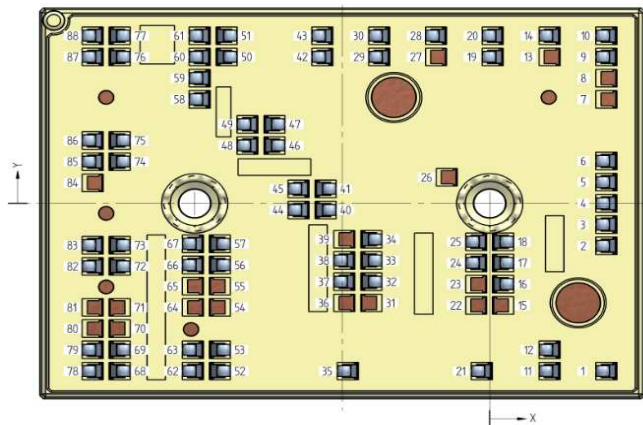


Ordering Code and Marking - Outline - Pinout

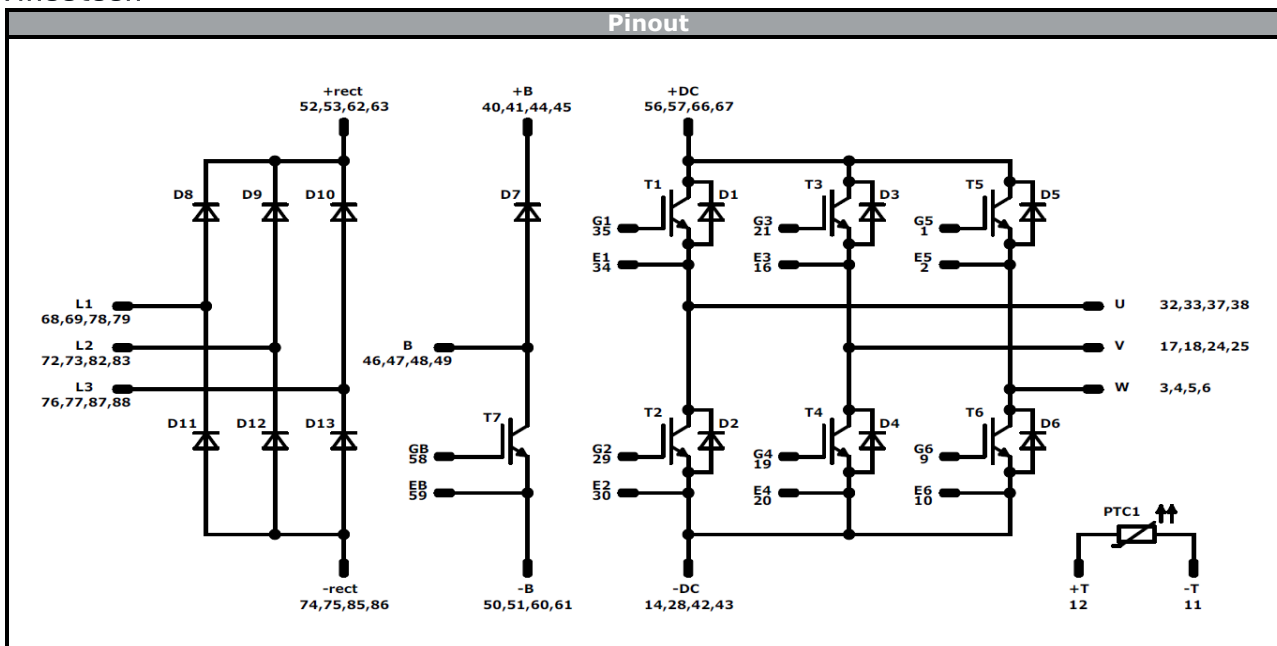
| Version | | Ordering Code | | | | | |
|---|----------|-------------------------|-----------|-------|--------|--|--|
| with std lid (black V23990-K32-T-PM) | | V23990-K429-A60-/0A/-PM | | | | | |
| with std lid (black V23990-K32-T-PM) and P12 | | V23990-K429-A60-/1A/-PM | | | | | |
| with thin lid (white V23990-K33-T-PM) | | V23990-K429-A60-/0B/-PM | | | | | |
| with thin lid (white V23990-K33-T-PM) and P12 | | V23990-K429-A60-/1B/-PM | | | | | |
| Text | VIN | Name&Ver | UL | Lot | Serial | | |
| | VIN | NNNNNNVV | UL | LLLLL | SSSS | | |
| Datamatrix | Name&Ver | Serial | Date code | | | | |
| | NNNNNNVV | SSSS | WWYY | | | | |

| Pad table [mm] | | | | Pad table [mm] | | | |
|----------------|---------------|--------|----------|----------------|---------------|-------|----------|
| Pad | X | Y | Function | Pad | X | Y | Function |
| 1 | 15,83 | -25,3 | G5 | 45 | -25,9 | 2,2 | +B |
| 2 | 15,83 | -6,4 | E5 | 46 | 10,82 | 8,74 | B |
| 3 | 15,83 | -3,2 | W | 47 | 10,82 | 11,94 | B |
| 4 | 15,83 | 0 | W | 48 | -32,82 | 8,74 | B |
| 5 | 15,83 | 3,2 | W | 49 | -32,82 | 11,94 | B |
| 6 | 15,83 | 6,4 | W | 50 | 4,32 | 22,1 | -B |
| 7 | Not assembled | | | 51 | 4,32 | 25,3 | -B |
| 8 | Not assembled | | | 52 | 3,42 | -25,3 | +rect |
| 9 | 15,83 | 22,1 | G6 | 53 | 3,42 | -22,1 | +rect |
| 10 | 15,83 | 25,3 | E6 | 54 | Not assembled | | |
| 11 | 8,13 | -25,3 | -T | 55 | Not assembled | | |
| 12 | 8,13 | -22,1 | +T | 56 | 3,42 | -9,3 | +DC |
| 13 | Not assembled | | | 57 | 3,42 | -6,1 | +DC |
| 14 | 8,13 | 25,3 | -DC | 58 | -39,32 | 15,7 | GB |
| 15 | Not assembled | | | 59 | -39,32 | 18,9 | EB |
| 16 | 41,82 | -12,18 | E3 | 60 | -39,32 | 22,1 | -B |
| 17 | 41,82 | -8,98 | V | 61 | -39,32 | 25,3 | -B |
| 18 | 41,82 | -5,79 | V | 62 | -40,22 | -25,3 | +rect |
| 19 | 0,43 | 22,1 | G4 | 63 | -40,22 | -22,1 | +rect |
| 20 | 0,43 | 25,3 | E4 | 64 | Not assembled | | |
| 21 | -1,07 | -25,3 | G3 | 65 | Not assembled | | |
| 22 | Not assembled | | | 66 | -40,22 | -9,3 | +DC |
| 23 | Not assembled | | | 67 | -40,22 | -6,09 | +DC |
| 24 | -1,82 | -8,98 | V | 68 | -10,18 | -25,3 | L1 |
| 25 | -1,82 | -5,79 | V | 69 | -10,18 | -22,1 | L1 |
| 26 | Not assembled | | | 70 | Not assembled | | |
| 27 | Not assembled | | | 71 | Not assembled | | |
| 28 | -7,27 | 25,3 | -DC | 72 | -10,18 | -9,5 | L2 |
| 29 | -14,97 | 22,1 | G2 | 73 | -10,18 | -6,3 | L2 |
| 30 | -14,97 | 25,3 | E2 | 74 | -10,18 | 6,3 | -rect |
| 31 | Not assembled | | | 75 | -10,18 | 9,5 | -rect |
| 32 | 23,95 | -11,82 | U | 76 | -10,18 | 22,1 | L3 |
| 33 | 23,95 | -8,63 | U | 77 | -10,18 | 25,3 | L3 |
| 34 | 23,95 | -5,42 | E1 | 78 | -53,82 | -25,3 | L1 |
| 35 | -19,22 | -25,3 | G1 | 79 | -53,82 | -22,1 | L1 |
| 36 | Not assembled | | | 80 | Not assembled | | |
| 37 | -19,7 | -11,82 | U | 81 | Not assembled | | |
| 38 | -19,7 | -8,62 | U | 82 | -53,82 | -9,5 | L2 |
| 39 | Not assembled | | | 83 | -53,82 | -6,3 | L2 |
| 40 | 17,74 | -1 | +B | 84 | Not assembled | | |
| 41 | 17,74 | 2,2 | +B | 85 | -53,82 | 6,3 | -rect |
| 42 | -22,67 | 22,1 | -DC | 86 | -53,82 | 9,5 | -rect |
| 43 | -22,67 | 25,3 | -DC | 87 | -53,82 | 22,1 | L3 |
| 44 | -25,9 | -1 | +B | 88 | -53,82 | 25,3 | L3 |

Outline



Pad positions refers to center point.
For more informations on pad design please see package data



| Identification | | | | | |
|--------------------------|------------|---------|---------|-----------------|---------|
| ID | Component | Voltage | Current | Function | Comment |
| T1,T2,T3,T4,T5,T6 | IGBT | 1200 V | 75 A | Inverter Switch | |
| D1,D2,D3,D4,D5,D6 | FWD | 1200 V | 75 A | Inverter Diode | |
| T7 | IGBT | 1200 V | 75 A | Brake Switch | |
| D7 | FWD | 1200 V | 75 A | Brake Diode | |
| D8,D9,D10 D11,D12,D13 | Rectifier | 1600 V | 50 A | Rectifier Diode | |
| PTC1 | Thermistor | | | Thermistor | |

**Packaging instruction**

| | | | | | |
|-----------------------------------|------------|------|----------|------|--------|
| Standard packaging quantity (SPQ) | 198 | >SPQ | Standard | <SPQ | Sample |
|-----------------------------------|------------|------|----------|------|--------|

Handling instruction

Handling instructions for MiniSkiiP® 3 packages see vincotech.com website.

Package data

Package data for MiniSkiiP® 3 packages see vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



| Document No.: | Date: | Modification: | Pages |
|-----------------------|--------------|---------------------------------|-------|
| V23990-K429-A60-D2-14 | 05 Aug. 2016 | New brand, new outline drawings | all |

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